

Application Data Sheet

Application Information

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Title ::

METHOD FOR TESTING
SEMICONDUCTOR FILM,
SEMICONDUCTOR DEVICE
AND MANUFACTURING
METHOD THEREOF

Attorney Docket Number::

0756-7275

Total Drawing Sheets::

24

Small Entity?::

No

Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Given Name::

Hidekazu

Middle Name::

Family Name::

MIYAIRI

Name Suffix::

City of Residence::

Tochigi

State or Province of Residence::

Tochigi

Country of Residence::

Japan

Street of mailing address::

c/o Semiconductor Energy
Laboratory Co., Ltd.

398, Hase
Atsugi-shi
Kanagawa-ken
Japan
243-0036

City of mailing address::
State or Province of mailing address::
Country of mailing address::
Postal or Zip Code of mailing address::

Inventor
Japan
Hideyuki
EBINE

Applicant Authority Type::
Primary Citizenship Country::
Given Name::
Middle Name::
Family Name::
Name Suffix::
City of Residence::
State or Province of Residence::
Country of Residence::
Street of mailing address::
City of mailing address::
State or Province of mailing address::
Country of mailing address::
Postal or Zip Code of mailing address::

Atsugi
Kanagawa
Japan
c/o Semiconductor Energy
Laboratory Co., Ltd.
398, Hase
Atsugi-shi
Kanagawa-ken
Japan
243-0036

Correspondence Information

Correspondence Customer Number :: 31780
E-Mail address:: erobinson@ripl.com

Representative Information

Representative Customer Number:: 31780

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-085096	03/26/2003	Yes

Assignee Information

Assignee name:: Semiconductor Energy
Laboratory Co., Ltd.

Street of mailing address:: 398 Hase

City of mailing address:: Atsugi-shi

State or Province of mailing address:: Kanagawa-ken

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 243-0036